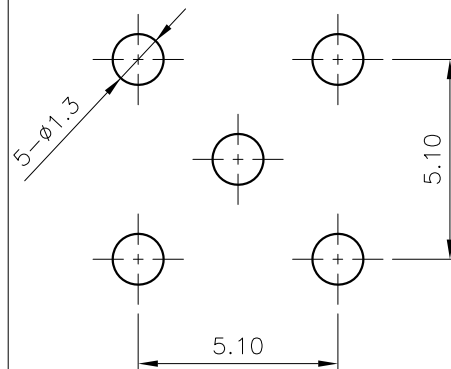
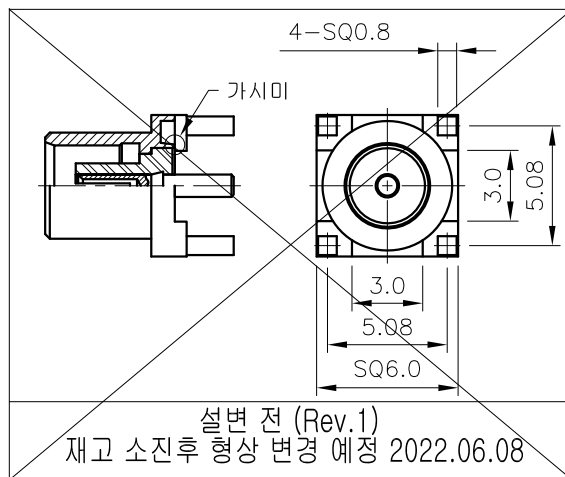
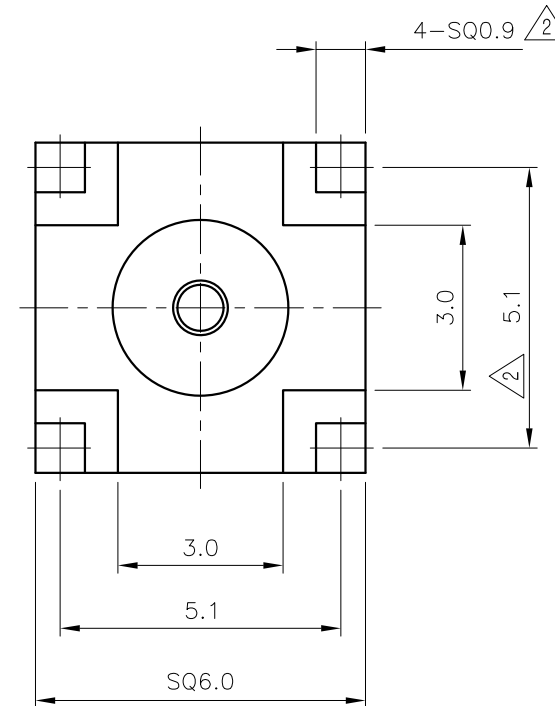
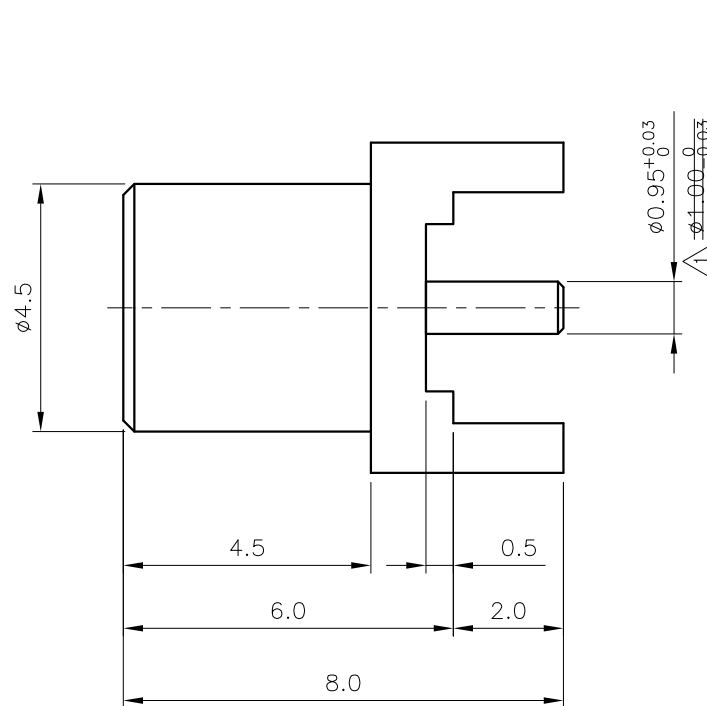


REVISION					
REV	DESCRIPTION		DRAWN	APPR	DATE
IR	Initial Registration		M.H.SONG	I.C.KIM	2002.10.29.
1	[설변No.201404-0006]조립성 향상(CONTACT,INSULATOR 구성 변경)		M.H.SONG	I.C.KIM	2014.04.21.
2	[설변No.202206-0002]사각사이즈 PCB리드부 사각과 일치하게 단순화 설변		S.H.KIM		2022.06.08.



2	1	3	INSULATOR	1	TEFLON		DIN02380-N/2
1	2	2	CONTACT	1	BeCu C17300	Gold Plate	DCT03115-5/1
2	1	1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD00076-5/3
		NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2022. 06. 08.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle ±1°	APPROVED BY					
MATERIAL _____		CHECKED BY			TITLE MCX50 PCB JS-4R		
		DRAWN BY S.H.KIM					
FINISH _____	SCALE 7/1	UNIT mm			A4	DWG NO. CN00723-7/1	
					REVISION 2	SHEET 1 of 1	

설변 전 (Rev.1)
재고 소진후 형상 변경 예정 2022.06.08

PCB MOUNTING HOLE SIZE